### VSMB2943RGX01, VSMB2943GX01

• Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55



**Vishay Semiconductors** 

# High Speed Infrared Emitting Diodes, 940 nm, GaAIAs, MQW

**FEATURES** 

 Package type: surface mount Package form: GW, RGW

Peak wavelength: λ<sub>p</sub> = 940 nm

• Angle of half intensity:  $\phi = \pm 25^{\circ}$ 

· Suitable for high pulse current operation

Floor life: 4 weeks, MSL 2a, acc. J-STD-020

please see www.vishay.com/doc?99912

• Terminal configurations: gullwing or reserve gullwing

• Package matches with detector VEMD2xx3X01 and

· Material categorization: For definitions of compliance

AEC-Q101 qualified

· High radiant power

· High radiant intensity

· Low forward voltage

VEMT2xx3X01 series

High reliability



#### DESCRIPTION

VSMB2943X01 series are infrared, 940 nm emitting diodes in GaAlAs multi quantum well (MQW) technology with high radiant power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

### **APPLICATIONS**

- IrDA compatible data transmission
- Miniature light barrier
- IR touch panels
- 3D TV
- Photointerrupters
- Optical switch
- · Control and drive circuits
- Shaft encoders

#### **PRODUCT SUMMARY**

#### l<sub>e</sub> (mW/sr) COMPONENT λ<sub>p</sub> (nm) φ (deg) t<sub>r</sub> (ns) VSMB2943RGX01 ± 25 20 940 15 VSMB2943GX01 20 ± 25 940 15

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION							
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM				
VSMB2943RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing				
VSMB2943GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing				

#### Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V <sub>R</sub>	5	V			
Forward current		I <sub>F</sub>	100	mA			
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I <sub>FM</sub>	200	mA			
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1	A			
Power dissipation		Pv	160	mW			
Junction temperature		Тj	100	°C			
Operating temperature range		T <sub>amb</sub>	- 40 to + 85	°C			
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C			
Soldering temperature	according figure 9, J-STD-020	T <sub>sd</sub>	260	°C			
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	R <sub>thJA</sub>	250	K/W			

Rev. 1.5, 26-Feb-13

Document Number: 83486

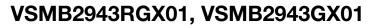


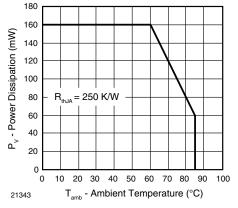
RoHS COMPLIANT GREEN (5-2008)

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Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

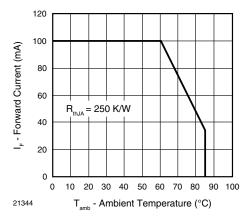


Fig. 2 - Forward Current Limit vs. Ambient Temperature

<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V <sub>F</sub>	1.15	1.35	1.6	V		
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	V <sub>F</sub>		2.2		V		
Temperature coefficient of $V_{F}$	I <sub>F</sub> = 1 mA	TK <sub>VF</sub>		- 1.8		mV/K		
	I <sub>F</sub> = 100 mA	TK <sub>VF</sub>		- 1.1		mV/K		
Reverse current	V <sub>R</sub> = 5 V	I <sub>R</sub>			10	μA		
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ		70		pF		
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l <sub>e</sub>	10	20	30	mW/sr		
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	l <sub>e</sub>		170		mW/sr		
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	φ <sub>e</sub>		40		mW		
Temperature coefficient of radiant power	I <sub>F</sub> = 1 mA	ΤΚφ <sub>e</sub>		- 1.1		%/K		
	I <sub>F</sub> = 100 mA	TKφ <sub>e</sub>		- 0.51		%/K		
Angle of half intensity		φ		± 25		deg		
Peak wavelength	I <sub>F</sub> = 30 mA	λ <sub>p</sub>	920	940	960	nm		
Spectral bandwidth	I <sub>F</sub> = 30 mA	Δλ		25		nm		
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 30 mA	TKλp		0.25		nm/K		
Rise time	$I_F = 100 \text{ mA}, 20 \% \text{ to } 80 \%$	t <sub>r</sub>		15		ns		
Fall time	$I_F = 100 \text{ mA}, 20 \% \text{ to } 80 \%$	t <sub>f</sub>		15		ns		
Cut-off frequency	$I_{DC} = 70$ mA, $I_{AC} = 30$ mA pp	f <sub>c</sub>		23		MHz		



### VSMB2943RGX01, VSMB2943GX01

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### BASIC CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

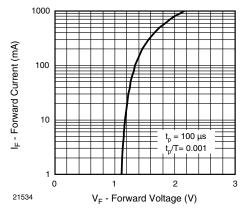


Fig. 3 - Forward Current vs. Forward Voltage

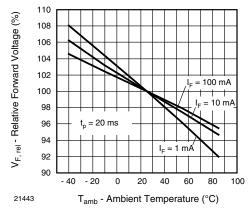


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

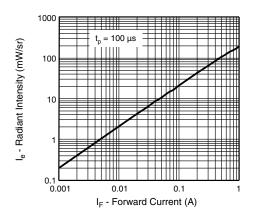


Fig. 5 - Radiant Intensity vs. Forward Current

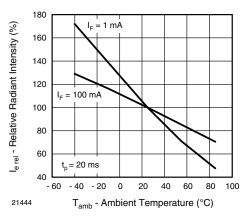


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

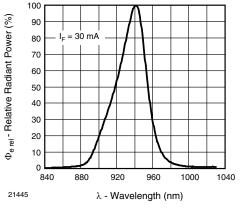


Fig. 7 - Relative Radiant Power vs. Wavelength

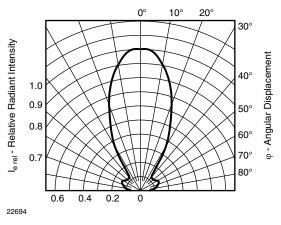


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

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### VSMB2943RGX01, VSMB2943GX01

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during

transportation and storage. Each bag contains a desiccant.

Floor life (time between soldering and removing from MBB)

In case of moisture absorption devices should be baked

before soldering. Conditions see J-STD-020 or label.

Devices taped on reel dry using recommended conditions

0.8

must not exceed the time indicated on MBB label:

Moisture sensitivity level 2a, acc. to J-STD-020.

Conditions: T<sub>amb</sub> < 30 °C, RH < 60 %

192 h at 40 °C (+ 5 °C), RH < 5 %.

DRYPACK

**FLOOR LIFE** 

Floor life: 4 weeks

DRYING

### **Vishay Semiconductors**

### SOLDER PROFILE

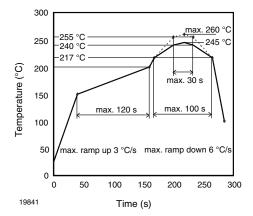
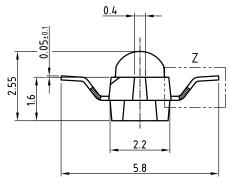
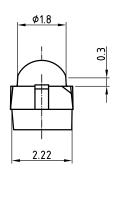
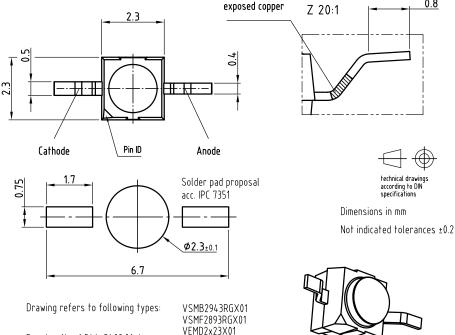


Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

#### PACKAGE DIMENSIONS in millimeters: VSMB2943RG







Drawing-No.: 6.544-5409.01-4 Issue: prel. 03.08.12

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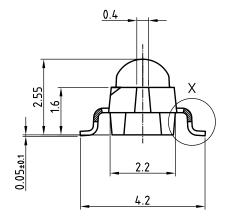
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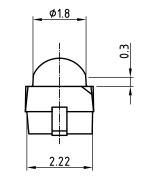
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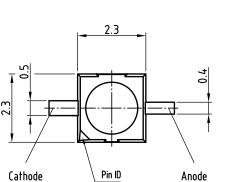
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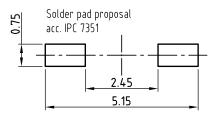


### PACKAGE DIMENSIONS in millimeters: VSMB2943G

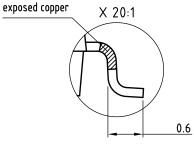






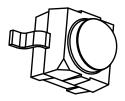


Drawing refers to following types: VSMB2943GX01 VSMF2893GX01 VEMD2x23X01 Issue: prel; 03.08.12





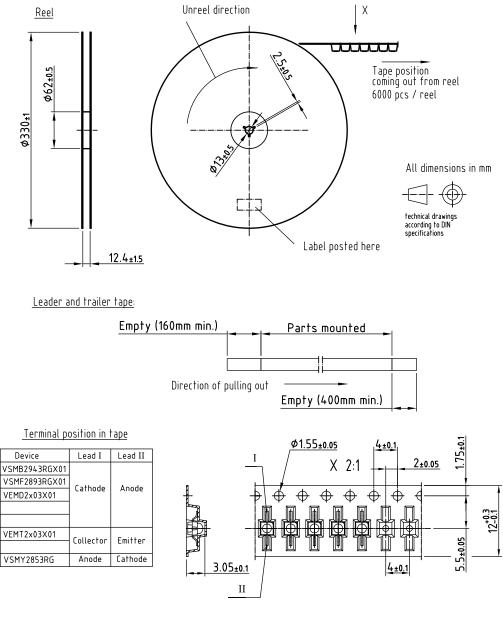
Dimensions in mm Not indicated tolerances ±0.2



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### TAPING AND REEL DIMENSIONS in millimeters: VSMB2943RG



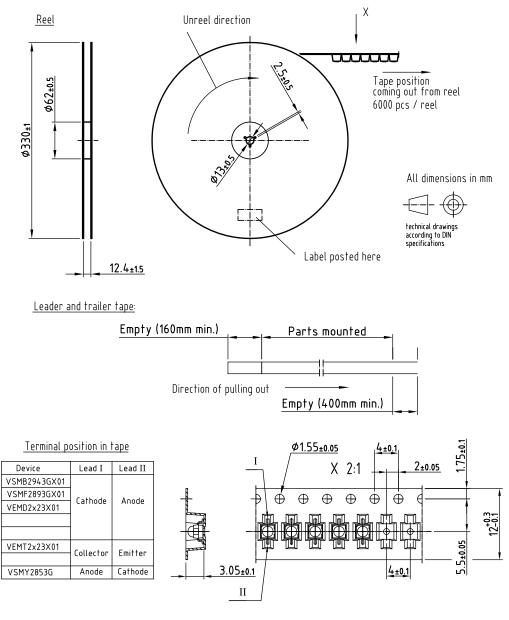
Drawing refers to following types: Reel dimensions and tape

see table

Drawing-No.: 9.800-5100.02-4 Issue: prel; 03.08.12



### TAPING AND REEL DIMENSIONS in millimeters: VSMB2943G



Drawing refers to following types: see table Reel dimensions and tape Drawing-No.: 9.800-5091.21-4 Issue: prel; 03.08.12

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